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Renesas Electronics Corporation

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H8/300L Super Low Power Series

Addition of Multiple-Precision Binary Numbers (ADD2)

Introduction

The software ADD2 adds a multiple-precision binary number to another multiple-precision binary number and places the result in the data memory where the augend was placed.

Target Device

H8/38024

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1. Arguments

Description	Memory area	Data length (bytes)
Input	Augend and addend byte length	R0L
	Start address of augend	R3
	Start address of addend	R4
Output	Start address of the result of addition	R3
	Error	Z flag (CCR)
	Carry	C flag (CCR)

2. Changes to Internal Registers and Flags

R0	R1	R2	R3	R4	R5	R6	R7
×	×	×	○	×	×	—	—
I	U	H	U	N	Z	V	C
—	—	×	—	×	○	×	○

Legend

- : No change
- ×: Undefined
- : Result

3. Specifications

Program memory (bytes)	42
Data memory (bytes)	0
Stack (bytes)	0
Clock cycle count	7170
Reentrant	Possible
Relocation	Possible
Interrupt	Possible

4. Notes

The clock cycle count (7170) in the specifications is for addition of 255 bytes to 255 bytes.

5. Description

5.1 Details of functions

1. The following arguments are used with the software ADD2:

R0L: Sets, as an input argument, the byte count of an augend and an addend in 2-digit hexadecimals.

R3: Contains the start address of the augend in the data memory area. The start address of the result of addition is placed in this register after execution of the software ADD2.

R4: Sets, as an input argument, the start address of the addend in the data memory area.

Z flag (CCR): Indicates an error in data length as an output argument.

Z flag = 0: The data byte count (R0L) was not 0.

Z flag = 1: The data byte count (R0L) was 0 (indicating an error).

C flag (CCR): Indicates the presence or absence of a carry, as an output argument, after execution of the software ADD2.

C flag = 0: No carry occurred in the result of addition.

C flag = 1: A carry occurred in the result of addition (see figure 2).

2. The following figure illustrates the execution of the software ADD2. When the input arguments are set as shown in (1), the result of addition is placed in the data memory area as shown in (2).

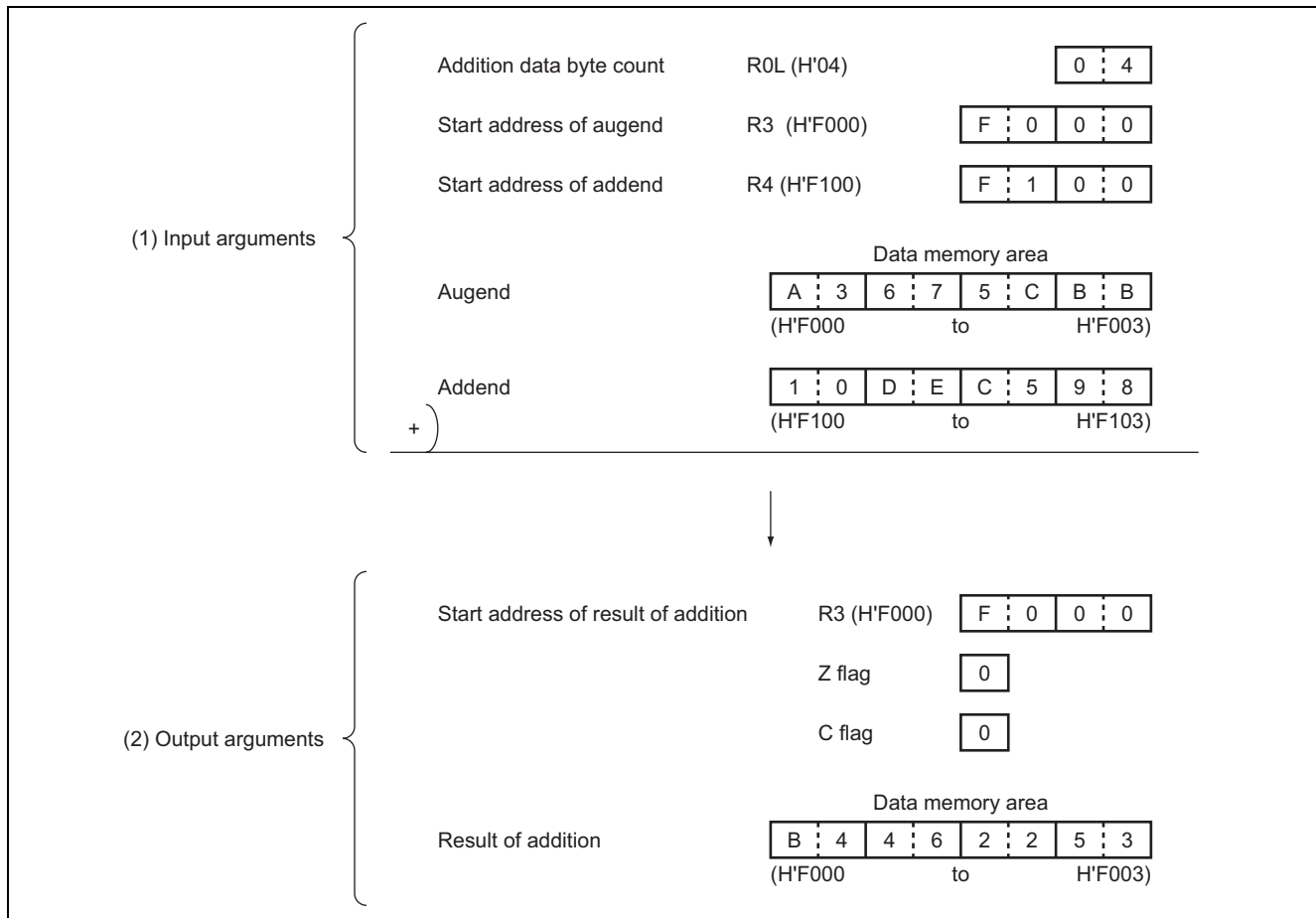


Figure 1 Example of Software ADD2 Execution

Figure 2 shows an example of addition with a carry that occurred in the result.

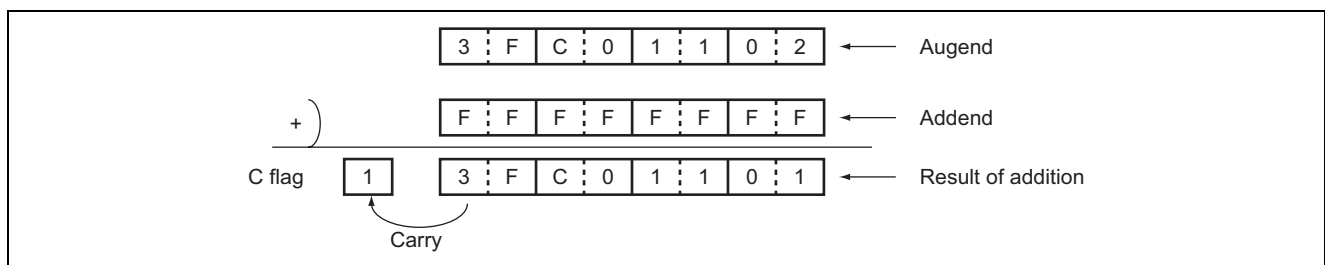


Figure 2 Example of Addition with a Carry

5.2 Notes on usage

1. When the upper bits are not used (see figure 3), set them to 0. The software ADD2 performs byte-based addition; when 0 are not set in the unused upper bits, a correct result cannot be obtained because the addition is done on the numbers including indeterminate data.

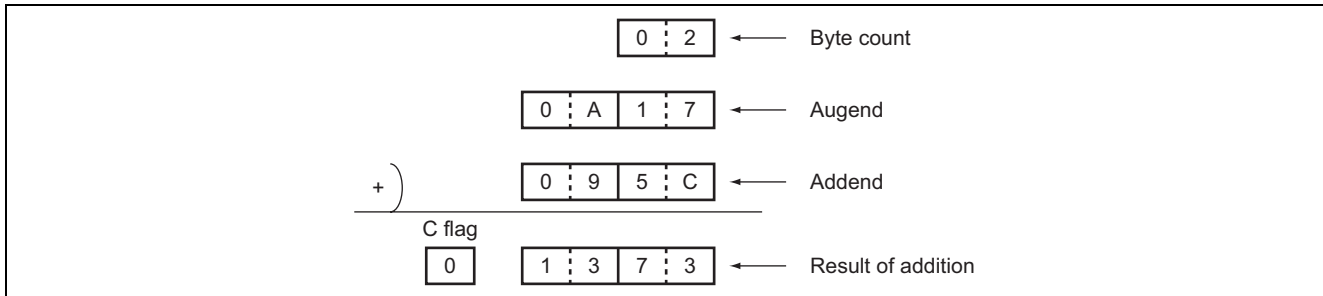


Figure 3 Example of Addition with Upper Bits Unused

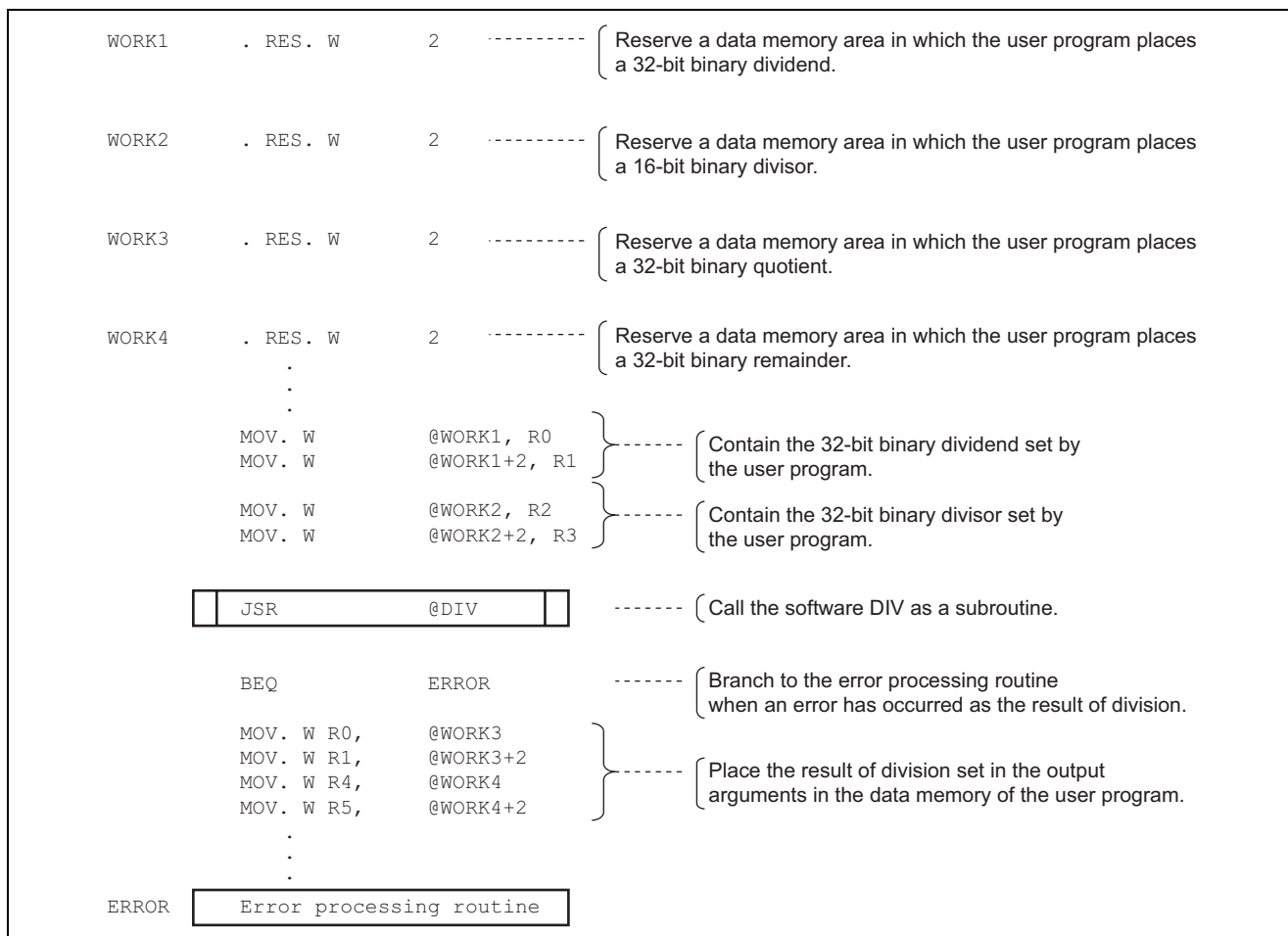
2. After execution of the software ADD2, the augend will be lost because the result is placed in the data memory area where the augend was set. When the augend is still needed after software ADD2 execution, save it in memory.

5.3 Data memory

The software ADD2 uses no data memory.

5.4 Example of usage

This is an example of adding 8 bytes of data. Set the start addresses of a byte count, an augend and an addend in the registers and call the software ADD2 as a subroutine.



5.5 Operation

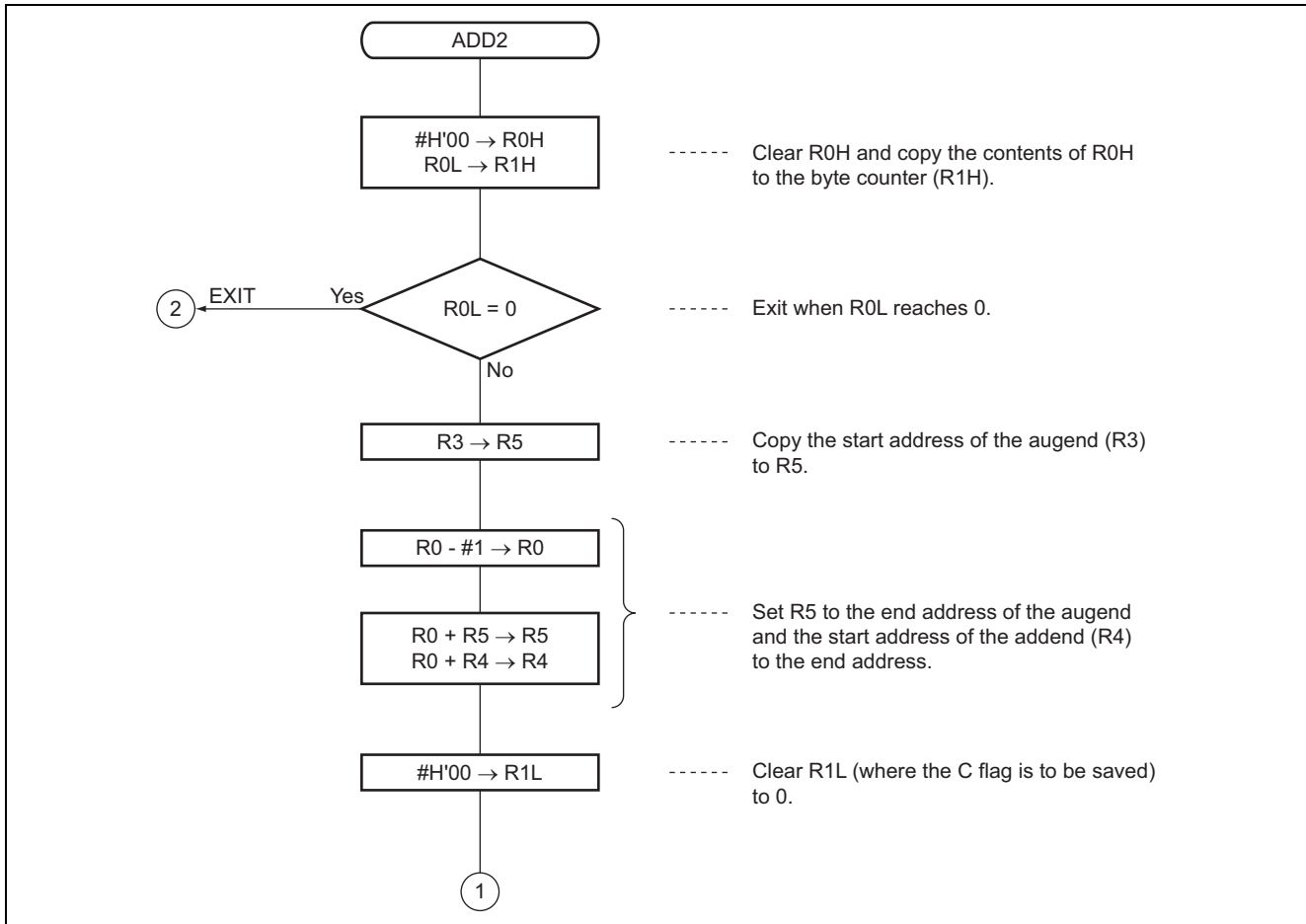
1. Addition of multiple-precision binary numbers can be done by performing a series of addb instructions with a carry flag (ADDX.B) as the augend and addend data are placed in registers on a byte basis.
2. The end address of the data memory area containing the augend is placed in R3, and the end address of the data memory area containing the addend is placed in R4.
3. R1L is cleared for saving the C flag.
4. The augend and addend are loaded in R2L and R2H respectively, byte by byte, starting at their end address and equation 1 is executed:

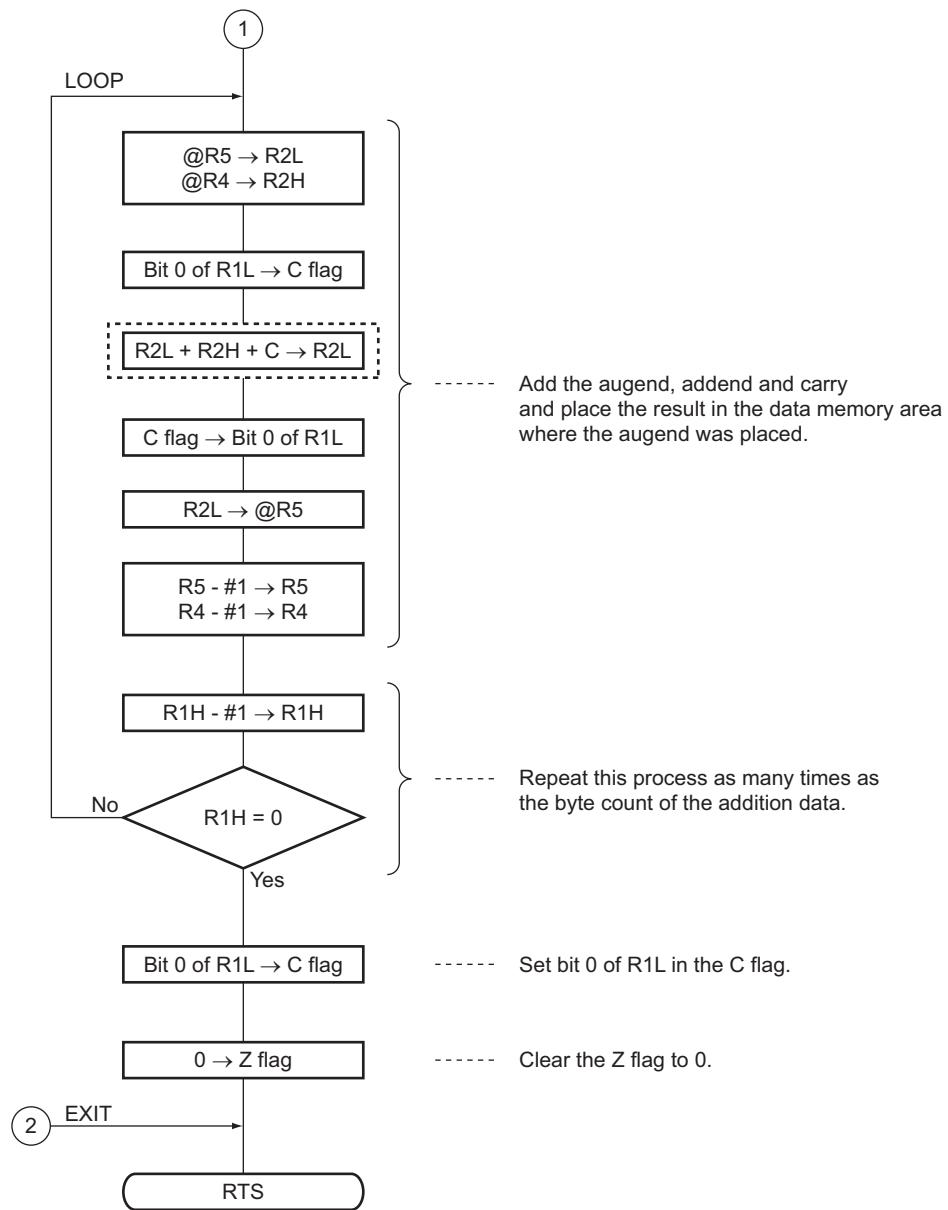
$$\left. \begin{array}{l} \text{Augend} + \text{addend} + C \rightarrow R2L \\ R2L \rightarrow @R3 \end{array} \right\} \text{----- equation 1}$$

where the C flag indicates a carry that may occur in the result of addition of the lower bytes.

5. The result of step 4 is placed in the data memory area for the augend.
6. R3, R4, and R0L are decremented each time the operation of steps 4 and 5 has finished. This processing is repeated until R0L reaches 0.

6. Flowchart





Note: ADD2 is the same as SUB2, ADDD2 and SUBD2 except for the stop surrounded by dotted lines.

7. Program List

```

*** H8/300 ASSEMBLER VER 1.0B ** 08/18/92 09:59:33
PROGRAM NAME =
1          ;*****
2          ;*
3          ;*      00 - NAME      :MULTIPLE PRECISION BINARY ADDITION
4          ;*                               (ADD2)
5          ;*
6          ;*****
7          ;*
8          ;*      ENTRY      :R0L (BYTE LENGTH OF ADDTION DATA)
9          ;*                               R3 (START ADDRESS OF SUMMAND)
10         ;*                               R4 (START ADDRESS OF ADDEND)
11         ;*
12         ;*      RETURNS   :R3 (START ADDRESS OF RESULT)
13         ;*                               Z flag OF CCR (Z=0;TRUE , Z=1;FALSE)
14         ;*                               C flag OF CCR (C = 0;TRUE , C = 1;OVER FLOW)
15         ;*
16         ;*****
17         ;
18 ADD2_cod C      0000          .SECTION          ADD2_code,CODE,ALIGN=2
19                               .EXPORT  ADD2
20         ;
21 ADD2_cod C      0000 00000000 ADD2 .EQU $          ;Entry point
22 ADD2_cod C      0000 F000          MOV.B      #H'00,R0H      ;Clear R0H
23 ADD2_cod C      0002 0C81          MOV.B      R0L,R1H      ;Set byte counter(R1H)
24 ADD2_cod C      0004 4722          BEQ      EXIT          ;Branch if R0L=0
25 ADD2_cod C      0006 0D35          MOV.W     R3,R5        ;R3 -> R5
26 ADD2_cod C      0008          MAIN
27 ADD2_cod C      0008 1B00          SUBS.W   #1,R0        ;Decrement R0
28 ADD2_cod C      000A 0905          ADD.W    R0,R5        ;Set start address of summand(R5)
29 ADD2_cod C      000C 0904          ADD.W    R0,R4        ;Set start address of addend(R4)
30 ADD2_cod C      000E F900          MOV.B    #H'00,R1L    ;Clear R1L
31 ADD2_cod C      0010          LOOP
32 ADD2_cod C      0010 685A          MOV.B    @R5,R2L      ;Load summand to R2L
33 ADD2_cod C      0012 6842          MOV.B    @R4,R2H      ;Load addend to R2H
34 ADD2_cod C      0014 7709          BLD      #0,R1L      ;Load bit 0 of R1L to C flag
35 ADD2_cod C      0016 0E2A          ADDX.B   R2H,R2L      ;Addition
36 ADD2_cod C      0018 6709          BST      #0,R1L      ;Store C flag to bit 0 of R1L
37 ADD2_cod C      001A 68DA          MOV.B    R2L,@R5     ;Store result
38 ADD2_cod C      001C 1B05          SUBS.W   #1,R5        ;Decrement summand address(R5)
39 ADD2_cod C      001E 1B04          SUBS.W   #1,R4        ;Decrement addend address(R4)
40 ADD2_cod C      0020 1A01          DEC.B    R1H          ;Decrement byte counter(R1H)
41 ADD2_cod C      0022 46EC          BNE      LOOP        ;Branch if Z=0
42         ;
43 ADD2_cod C      0024 7709          BLD      #0,R1L      ;Load bit 0 of R1L to c flag
44 ADD2_cod C      0026 06FB          ANDC.B   #H'FB,CCR    ;Clear Z flag
45 ADD2_cod C      0028          EXIT
46 ADD2_cod C      0028 5470          RTS
47         ;
48         .END
****TOTAL ERRORS 0
****TOTAL WARNINGS 0

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